Onsemi

MOSFET – Power, Single N-Channel, SUPÉRFET[®] V, FRFET[®], TO247-3L 600 V, 55 mΩ, 45 A NVHL055N60S5F

Description

The SUPERFET V MOSFET FRFET series has optimized body diode performance characteristics. This can allow for the removal of components in the application and improve application performance and reliability, particularly when soft switching topologies are used.

Features

- $650 \text{ V} @ \text{T}_{\text{J}} = 150^{\circ}\text{C} / \text{Typ. } \text{R}_{\text{DS(on)}} = 44 \text{ m}\Omega$
- 100% Avalanche Tested
- Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- Electric Vehicle On Board Chargers
- EV Main Battery DC/DC Converters

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

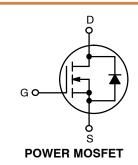
Parameter		Symbol	Value	Unit	
Drain-to-Source Voltage		V _{DSS}	600	V	
Gate-to-Source Voltage DC		V _{GS}	±30	V	
	AC (f > 1 Hz)		±30		
Continuous Drain Current	T _C = 25°C	۱ _D	45	А	
	T _C = 100°C		28		
Power Dissipation	T _C = 25°C	PD	278	W	
Pulsed Drain Current	Τ 0500	I _{DM}	159	А	
Pulsed Source Current (Body Diode)	T _C = 25°C, t _P = 10 μs	I _{SM}	159		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	–55 to +150	°C	
Source Current (Body Diode)		۱ _S	45	А	
Single Pulse Avalanche Energy	$(I_L = 7 \text{ A}, R_G = 25 \Omega)$	E _{AS}	417	mJ	
Avalanche Current		I _{AS}	I _{AS} 7		
Repetitive Avalanche Energy (Note 1)		E _{AR}	2.78	mJ	
MOSFET dv/dt		dvdt	dvdt 120		
Peak Diode Recovery dv/dt (Note 2)			70		
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		ΤL	260	°C	

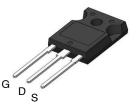
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Repetitive rating: pulse-width limited by maximum junction temperature.

2. $I_{SD} \le 22.5$ A, di/dt ≤ 200 A/µs, $V_{DD} \le 400$ V, starting $T_J = 25^{\circ}$ C.

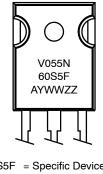
V _{DSS}	V _{DSS} R _{DS(ON)} MAX	
600 V	55 mΩ @ 10 V	45 A





TO-247 Long Leads CASE 340CX

MARKING DIAGRAM



V055N60S5F = Specific Device Code = Assembly Location YWW = Data Code (Year & Week) = Assembly Lot

А

ΖZ

ORDERING INFORMATION

Device	Package	Shipping		
NVHL055N60S5F	TO-247	30 Units / Tube		

THERMAL RESISTANCE

Reverse Recovery Time

Reverse Recovery Charge

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case, Max.	$R_{\theta JC}$	0.45	°C/W
Thermal Resistance, Junction-to-Ambient, Max.	$R_{\theta JA}$	40	

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
OFF CHARACTERISTICS	•	•				
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I_D = 1 mA, T_J = 25 $^\circ C$	600	-	-	V
Drain-to-Source Breakdown Voltage Temperature Coefficient	$\Delta V_{(BR)DSS}/ \Delta T_J$	I_D = 10 mA, Referenced to 25°C	_	581	-	mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V_{GS} = 0 V, V_{DS} = 600 V, T_{J} = 25°C	_	-	10	μΑ
Gate-to-Source Leakage Current	I _{GSS}	$V_{GS}=\pm30~V,~V_{DS}=0~V$	Ι	-	±100	nA
ON CHARACTERISTICS						
Drain-to-Source On Resistance	R _{DS(on)}	V_{GS} = 10 V, I_D = 22.5 A, T_J = 25 $^\circ C$	_	44	55	mΩ
Gate Threshold Voltage	V _{GS(th)}	V_{GS} = V_{DS} , I_D = 5.2 mA, T_J = 25°C	3.2	-	4.8	V
Forward Trans-conductance	9FS	$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 22.5 \text{ A}$	-	44.8	-	S
CHARGES, CAPACITANCES & GATE	RESISTANCE					
Input Capacitance	C _{ISS}	V_{DS} = 400 V, V_{GS} = 0 V, f = 250 kHz	_	4603	-	– pF
Output Capacitance	C _{OSS}		-	72.9	-	
Time Related Output Capacitance	C _{OSS(tr.)}	$I_{D} = Constant, V_{DS} = 0 V to 400 V, \\ V_{GS} = 0 V$	_	1114	-	
Energy Related Output Capacitance	C _{OSS(er.)}	V_{DS} = 0 V to 400 V, V_{GS} = 0 V	-	125	-	
Total Gate Charge	Q _{G(tot)}	V_{DD} = 400 V, I _D = 22.5 A, V _{GS} = 10 V	-	85.2	-	nC
Gate-to-Source Charge	Q _{GS}		-	26.2	-	1
Gate-to-Drain Charge	Q _{GD}		-	24.9	-	
Gate Resistance	R _G	f = 1 MHz	-	4.32	-	Ω
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	t _{d(on)}	$\label{eq:VGS} \begin{array}{l} V_{GS} = 0/10 \; V, \; V_{DD} = 400 \; V, \\ I_{D} = 22.5 \; A, \; R_{G} = 4.7 \; \Omega \end{array}$	_	44	-	ns
Rise Time	t _r		-	26.2	-	
Turn-Off Delay Time	t _{d(off)}]	_	108	-	1
Fall Time	t _f	1	-	2.6	-	1
SOURCE-TO-DRAIN DIODE CHARAC	TERISTICS	•		-	-	
Forward Diode Voltage	V _{SD}	V_{GS} = 0 V, I_{SD} = 22.5 A, T_J = 25 $^\circ C$	-	-	1.2	V
				1	1	1

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

t_{RR}

 $\mathsf{Q}_{\mathsf{R}\mathsf{R}}$

 $\begin{array}{l} V_{GS} = 0 \ V, \ I_{SD} = 22.5 \ A, \\ dI/dt = 100 \ A/\mu s, \ V_{DD} = 400 \ V \end{array}$

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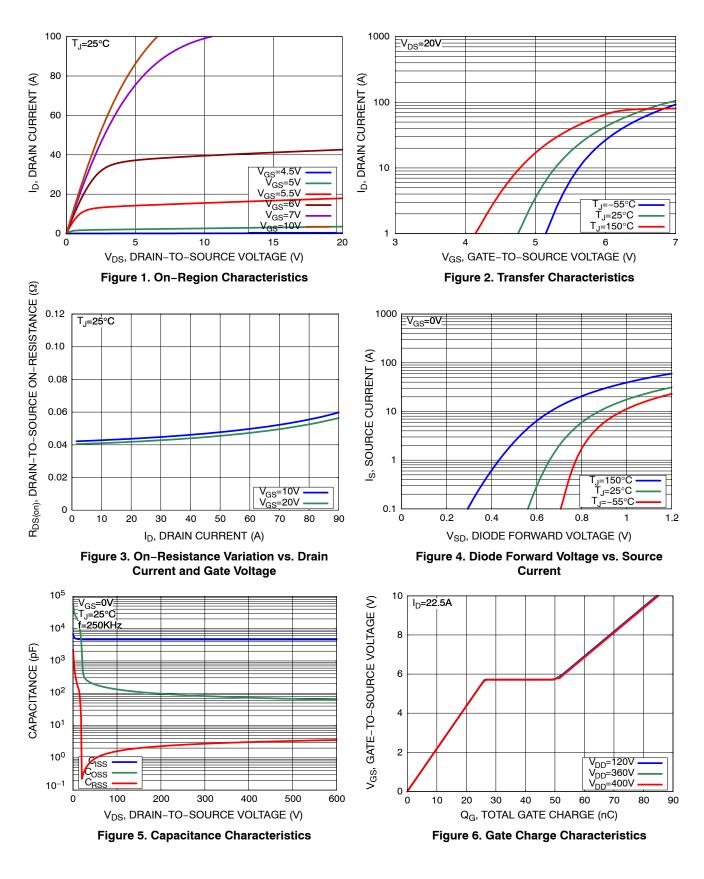
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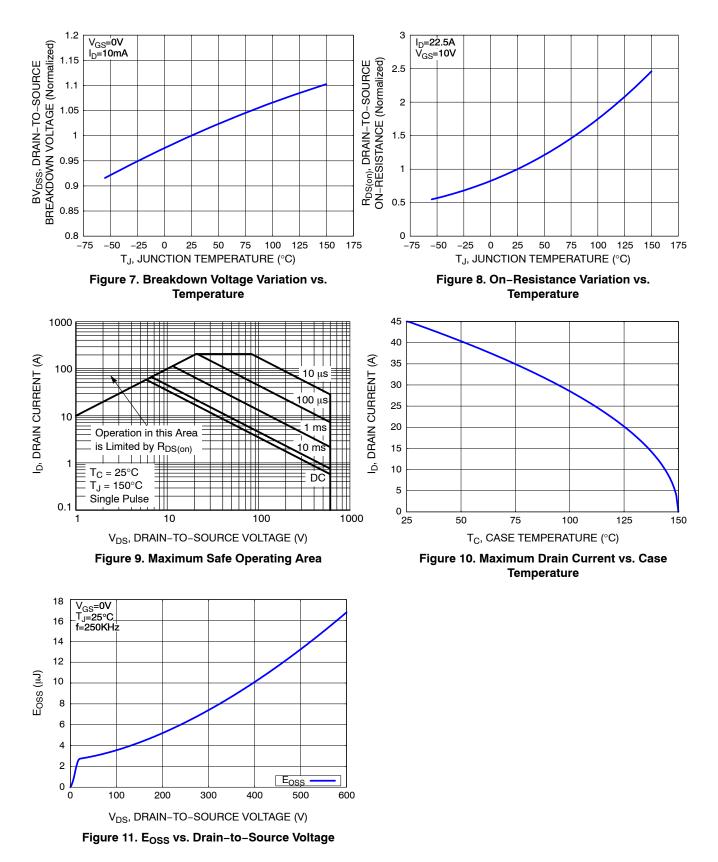
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TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

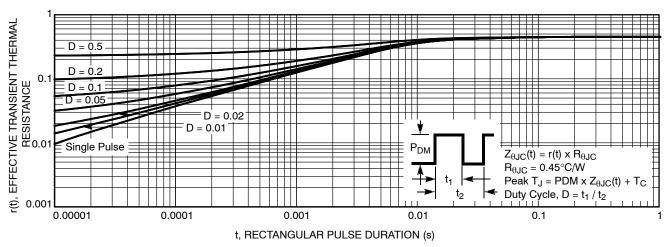


Figure 12. Transient Thermal Impedance

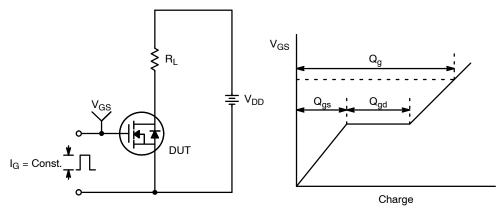


Figure 13. Gate Charge Test Circuit & Waveform

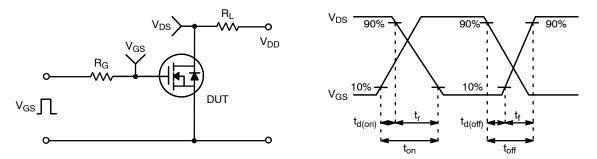


Figure 14. Resistive Switching Test Circuit & Waveforms

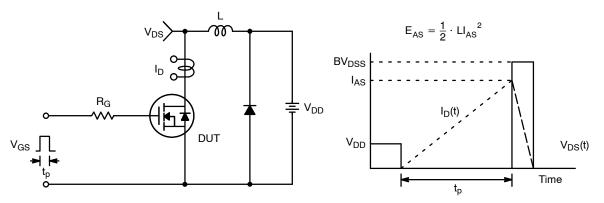


Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms

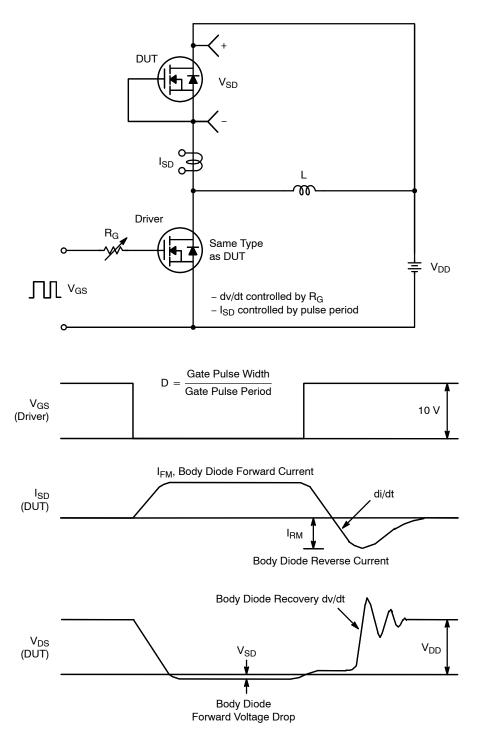
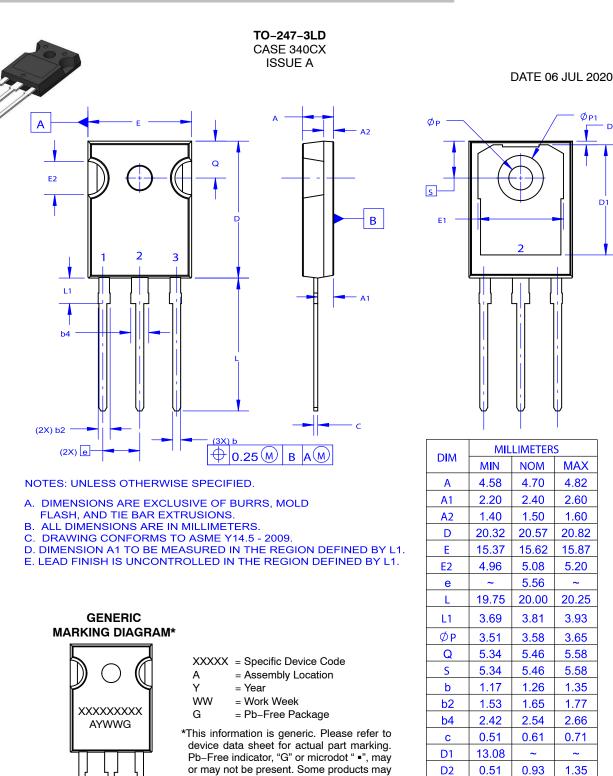


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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